Dated the 23rd day of June, 2026

WILLAS-ARRAY ELECTRONIC (HOLDINGS) LIMITED
威雅利電子(集團)有限公司

and

SHANGHAI YCT ELECTRONICS GROUP CO LTD
上海雅創電子集團股份有限公司

SUPPLEMENTAL PURCHASE DEED IN RELATION TO THE MASTER PURCHASE FRAMEWORK AGREEMENT

THIS DEED (this "Deed") is made on the 23rd day of June, 2026.

BETWEEN:

(1) **WILLAS-ARRAY ELECTRONICS (HOLDINGS) LIMITED 威雅利電子(集團)有限公司**, a company incorporated in Bermuda and listed on the and having its registered office at Victory Place, 5/F, 31 Victoria Street, Hamilton HM10, Bermuda and whose principal place of business and head office in Hong Kong is at 24/F, Wyler Centre, Phase 2, 200 Tai Lin Pai Road, Kwai Chung, New Territories, Hong Kong (the "**Company**"), for itself and on behalf of each of its subsidiaries (collectively, the "**Purchase Group**"); and

(2) **SHANGHAI YCT ELECTRONICS GROUP CO LTD 上海雅創電子集團股份有限公司**, a company incorporated in the PRC with limited liability and listed on the Shenzhen Stock Exchange (stock code: 301099) whose registered address is at Unit 402-405 and 2/F, 3/F, No. 62, Lane 99, Chunguang Road, Minhang District, Shanghai, PRC (the "**Seller**"), for itself and on behalf of its subsidiaries (collectively, the "**Seller Group**").

WHEREAS:

(A) The Company and the Seller entered into a framework agreement dated January 1, 2026 (the "**Master Purchase Framework Agreement**") in relation to the sale and purchase of the Products between the Seller Group and the Purchaser Group.

(B) Following the execution of the Master Purchase Framework Agreement, having taken into account the (i) actual transaction amount for the period from January 1, 2026 up to May 31, 2026; (ii) the estimated transaction amount for the remaining period up to December 31, 2026; and (iii) the remaining effective term of the Master Purchase Framework Agreement, the Company expects that the existing annual cap and the remaining term for the continuing connected transactions contemplated under the Master Purchase Framework Agreement will not meet the needs of the Seller Group.

(C) In view of the above, the Company and the Seller have agreed to enter into this Deed to further amend and supplement the terms and conditions of the Master Purchase Framework Agreement.

NOW IT IS HEREBY AGREED as follows:

1. INTERPRETATION

1.1 Unless the context requires otherwise, capitalised terms shall have the meaning given to them in the Master Purchase Framework Agreement.

2. AMENDMENT

2.1 The entire clause 2.1 shall be deleted in its entirety and shall be replaced by the following:-

"2.1 Subject to the Conditions Precedent as set out in Clause 4 and other provisions of this Agreement, this Agreement shall come into force from the date of conclusion of the general meeting held by the Company to approve the Master Purchase Framework Agreement, the proposed annual caps and this Deed and, subject as provided in Clause 5, shall continue in force until December 31, 2028."

2.2 The entire clause 3.3 shall be deleted in its entirety and shall be replaced by the following:-

"*3.3 This clause sets out the proposed annual caps for the aggregate purchase amount of Products during the continuance of this Agreement.*

	For the year ending December 31, 2026 (HK$)	*For the year ending December 31, 2027 (HK$)*	*For the year ending December 31, 2028 (HK$)*
Proposed annual caps	*9,999,999*	*9,999,999*	*9,999,999*

3. CONDITIONS PRECEDENT

This Deed shall become effective upon the fulfilment of the following conditions precedent:

The Company having complied with all requirements as may be imposed by the Stock Exchange as a condition to the continuing connected transactions (including but not limited to obtaining independent shareholders' approval) taking effect under the Listing Rules, and other requirements as may be imposed by the Singapore Exchange Securities Trading Limited.

In the event that the above conditions precedent is not fulfilled by November 30, 2026, this Deed and all rights and obligations hereunder shall cease to be effective and no party shall have any claim against the other by reason thereof."

4. ACKNOWLEDGMENT

4.1 The parties acknowledge that, save as to the terms and conditions as amended by this Deed, the Master Purchase Framework Agreement shall remain in full force and effect.

5. GOVERNING LAW AND JURISDICTION

5.1 This Deed shall be governed by and construed in accordance with the laws of the Hong Kong Special Administrative Region of the People's Republic of China ("**Hong Kong**").

5.2 Each party hereto irrevocably agrees that the courts of Hong Kong shall have jurisdiction to hear and determine any suit, action or proceeding, and to settle any disputes which may arise out of or in connection with this Deed and for such purposes irrevocably submits to the non-exclusive jurisdiction of such courts.

6. INCONSISTENCY AND NO RETROSPECTIVE EFFECT

6.1 In the event of any inconsistency between provisions of this Deed and any other supplemental agreements executed, whichever executed later shall prevail.

6.2 The amendments to this Deed provided herein shall be applicable prospectively from the date of this Deed forward and shall have no retrospective effect.

IN WITNESS whereof the parties have executed this Deed on the date first mentioned.

SEALED with the COMMON SEAL of)
WILLAS-ARRAY ELECTRONICS)
(HOLDINGS) LIMITED)
and SIGNED by Li Wai and Huang Shaoli)
)
as duly authorised by resolutions of)
board of directors in the presence of :-)
Peng Yuanhua

Angela

SEALED with the COMMON SEAL of)
SHANGHAI YCT ELECTRONICS)
GROUP CO., LTD)
and SIGNED by Xie Lishu)
)
as duly authorised by resolutions of)
board of directors in the presence of :-)
Xie Yao